

1 Creation Road 3, Hsinchu Science Park, Hsinchu 30077,Taiwan,R.O.C.

Statement of Compliance

We declare, under our sole responsibility, that the products and components listed in this declaration comply with the regulations in the below list. We are willing to provide all necessary documentation or information to demonstrate our compliance with the below regulations. It is our responsibility to proactively inform our customer if we identify a potential risk of breaching the below regulations for our products and components.

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Accton Model P/N: F0PZZ5626002A

Accton Description: ??SWITCH ES5626BQ-1217-111ZZ(25G)(AC), 1 O

Customer Products P/N: 7316-26XB-O-AC-F

2. Classification:

☑ Full compliance with RoHS 2.0(2011/65/EU&(EU)2015/863&EN50581:2012)(Pb,Hg,Cr6+,PBB,PBDE,DEHP,DBP,BBP,DIBP <1000ppm;Cd<100ppm)
☐ Full compliance with RoHS 2.0(2011/65/EU&(EU)2015/863&EN50581:2012) (Pb,Hg,Cr6+,PBB,PBDE,DEHP,DBP,BBP,DIBP <1000ppm;Cd<100ppm)+Pl
Full compliance with China RoHS requirements (Pb,Hg,Cr6+,PBB,PBDE<1000ppm; Cd<100ppm)
Full compliance Korea RoHS requirements (Pb,Hg,Cr6+,PBB,PBDE<1000ppm; Cd<100ppm)
☐ Full compliance with REACH (EC 1907/2006)
☐ Full compliance with Taiwan RoHS-CNS 15663 requirements
Others
RoHS:
Mark Ballic 0/0044/05/EUL 9 (EU)0045/000) and use Ballic Expression as below:

Meet RoHS 2(2011/65/EU & (EU)2015/863) and use RoHS Exemption as below:

6(c): Copper alloy containing up to 4 % lead by weight .

7(a): Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead).

7(c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.

ChinaRoHS:

产品内含危害物质揭露表	Products	s contain haz	ardous substa	ances exposir	ng table	
	危害物质项目 Hazardous Substances Project					
零部件名称 Component Name	铅 (Pb)	镉 (Cd)	汞 (Hg)	六价铬 (Cr6+)	多溴联苯 (PBB)	多溴二苯乙 醚 (PBDE)
固态硬盘模块 SSD Module	Х	0	0	0	0	0
动态随机存取内存模块 SDRAM Module	Х	0	0	0	0	0
模块化组件 Module	Х	0	0	0	0	0
二极管 Diode	Х	0	0	0	0	0
场效应晶体管 Mosfet	Х	0	0	0	0	0
LAN变压器 LAN X'FMR	Х	0	0	0	0	0
突波吸收器 TVS Array	Х	0	0	0	0	0
石英震荡器 Crystal	X	0	0	0	0	0
保险丝 Fuse	Х	0	0	0	0	0
电压转换集成电路 Regulator	Х	0	0	0	0	0
风扇 Fan	Х	0	0	0	0	0
无线连接器 CONN RF	Х	0	0	0	0	0
螺丝 Screw	Х	0	0	0	0	0
螺帽 Nut	Х	0	0	0	0	0
间隔柱 Spacer	Х	0	0	0	0	0
电源供应器 Power supply	Х	0	0	0	0	0
电阻 Resistor	Х	0	0	0	0	0

本表格依据 SJ/T: 11364-2014 的规定编制。

X:表示此部件使用的至少一种同类材料中,此种有毒或有害物质的含量高于 GB/T 26572-2011 规定的限制要求。

X: indicates the toxic or hazardous substance content of the part (at the homogenous material level) is over the threshold defined by standard of GB/T 26572-2011("Contained" toxic or hazardous substances). Suppliers can explain the technical cause of "X" according to actual situation.

REACH

This statement reflects Products listed below that are manufactured by Accton Technology corporation are in compliance to Regulation (EC) No 1907/2006 of the European Parliament and of the Council of 18 December 2006 concerning the Registration, Evaluation, Authorization and Restriction of Chemicals (REACH). Substances of Very High Concern Candidate List by ECHA with latest publication date Jan 16 2020

According to the Article 33.2 of Regulation (EC) No1907/2006:

The manufacturer has the obligation for safety use to provide sufficient information to the consumer/recipient of the article if Substances of Very High Concern (SVHC) conform to the standard of Article 57 and the regulation of Article 59 (1) are contained in its products in a concentration above 0.1% weight by weight (w/w).

Accton will focus on the subject continually and conduct SVHC inventory accounting via supplier chain. And some measure be take and discuss the possibility of substitute with supplier if necessary.

Accton has identified materials within its products that may contain EU REACH SVHC candidate substances in excess of 0.1% by weight. The substances are:

^{○:}表示此部件使用的所有同类材料中此种有毒或有害物质的含量均低于 GB/T 26572-2011 规定的限制要求。

 [:] indicates the toxic or hazardous substance content of the part (at the homogenous material level) is lower than the threshold defined by Requirements for Concentration Limits for Toxic or hazardous Substances in Electronic Information Products(GB/T 26572-2011) issued by Chinese Ministry of Information Industry ("Not Contained" toxic or hazardous substances).

SVHCs in a concentration above 0.1% weight by weight	CAS No.
Cobalt(II) sulphate	10124-43-3
Lead titanium trioxide	12060-00-3
Diboron trioxide	1303-86-2
Lead oxide (lead monoxide)	1317-36-8
1,3,5-Tris(oxiran-2-ylmethyl)-1,3,5-triazinane-2,4,6-trione (TGIC)	2451-62-9
2-methyl-1-(4-methylthiophenyl)-2-morpholinopropan-1-one	71868-10-5
Lead	7439-92-1

TaiwanRoHS:

設備名稱:路由器 型號(型式): AS7316-26XB							
Equipment name	3	T	ype designation (Гуре)			
	限用物質及其化學符號 Restricted substances and its chemical symbols						
單元Unit	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominate d biphenyls (PBB)	多溴二苯醚 Polybrominate d diphenyl ethers (PBDE)	
電路板組件 PCBA	-	0	0	0	0	0	
風扇 Fan	-	0	0	0	0	0	
散熱器 Heatsink	0	0	0	0	0	0	
機殼 Chassis	14.0	0	0	0	0	0	
RF線材 RF Cable	0	0	0	0	0	0	
電源供應器 Power Supply	(=)	0	0	0	0	0	

備考1. "超出0.1 wt %"及"超出0.01 wt %"係指限用物質之百分比含量超出百分比含量基準值。

Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: "O" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. "- "係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.

Company : Accton Technology Corporation				
•	person in charge : _			
Signature :	Auburg Ch	en		

保存期限十年 FMC-CE05000-05 R07

Date: 2020/09/01